MOSEL VITELIC V62C2804096 512K X 8, CMOS STATIC RAM

PRELIMINARY

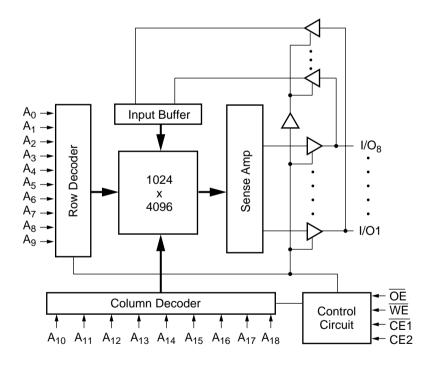
Features

- High-speed: 70, 85 ns
- Ultra low standby current of 4µA (max.)
- Fully static operation
- All inputs and outputs directly compatible
- Three state outputs
- Ultra low data retention current (V_{CC} = 1.2V)
- Operating voltage: 2.3V–3.0V
- Packages
 - 32-Pin TSOP (Standard)
 - 36-Ball CSP BGA (8mm x 10mm)

Description

The V62C2804096 is a very low power CMOS static RAM organized as 524,288 words by 8 bits. Easy memory expansion is provided by an active LOW $\overline{CE1}$, and active HIGH CE2, an active LOW \overline{OE} , and three static I/O's. This device has an automatic power-down mode feature when deselected.

Functional Block Diagram



Device Usage Chart

| Operating | Package | Outline | Access Time (ns) | | Power | | Townsteins | |
|----------------------|---------|---------|------------------|----|-------|----|---------------------|--|
| Temperature Range | т | В | 70 | 85 | L | LL | Temperature Mark | |
| 0°C to 70°C | • | • | • | • | • | • | Blank | |
| -40°C to +85°C | • | • | • | • | | • | I | |

Pin Descriptions

$A_0 - A_{18}$ **Address Inputs**

These 19 address inputs select one of the 512K x 8 bit segments in the RAM.

CE₁, CE₂* Chip Enable Inputs

 \overline{CE}_1 is active LOW and CE_2 is active HIGH. Both chip enables must be active to read from or write to the device. If either chip enable is not active, the device is deselected and is in a standby power mode. The I/O pins will be in the high-impedance state when deselected.

OE Output Enable Input

The Output Enable input is active LOW. With chip enabled, when \overline{OE} is LOW and \overline{WE} HIGH, data of the selected memory location will be available on the I/O pins. When \overline{OE} is HIGH, the I/O pins will be in the high impedance state.

1

 \bigcirc

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А

В

С

D

Е

F

G

н

*CE₂ is available on BGA package only.

WE Write Enable Input

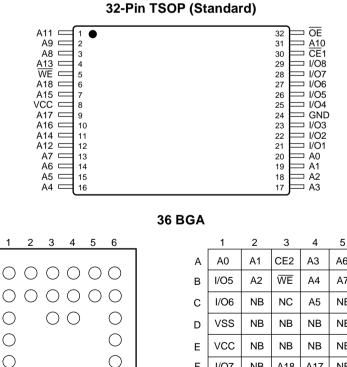
The write enable input is active LOW and controls read and write operations. With the chip enabled, when \overline{WE} is HIGH and \overline{OE} is LOW, output data will be present at the I/O pins; when \overline{WE} is LOW and OE is HIGH, the data present on the I/O pins will be written into the selected memory locations.

I/O₁–I/O₈ Data Input and Data Output Ports

These 8 bidirectional ports are used to read data from and write data into the RAM.

Power Supply V_{CC}

GND Ground



A6 A7 NB NB NB F I/07 A18 A17 NB NB G I/08 ŌĒ CE1 A16 A15 Α9 A10 A11 A12 A13 н

6

A8

I/O1

I/O2

VCC

VSS

I/O3

I/O4

A14

Note: NC means no connect. NB means no ball.

TOP VIEW

TOP VIEW

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0 0 0 0 0 0

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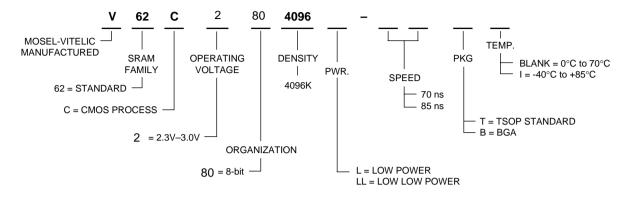
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Pin Configurations (Top View)

V62C2804096

V62C2804096

Part Number Information



Absolute Maximum Ratings (1)

| Symbol | Parameter | Commercial | Industrial | Units |
|-------------------|------------------------------|--------------------------|---------------------------------|-------|
| V _{CC} | Supply Voltage | -0.5 to + V_{CC} + 0.5 | -0.5 to + V _{CC} + 0.5 | V |
| V _N | Input Voltage | -0.5 to + V_{CC} + 0.5 | -0.5 to + V _{CC} + 0.5 | V |
| V _{DQ} | Input/Output Voltage Applied | V _{CC} + 0.3 | V _{CC} + 0.3 | V |
| T _{BIAS} | Temperature Under Bias | -10 to +125 | -65 to +135 | °C |
| T _{STG} | Storage Temperature | -55 to +125 | -65 to +150 | °C |

NOTE:

Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress
rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections
of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Capacitance*

| $T_{A} = 25^{\circ}C,$ | f = 1.0MF | Ηz |
|------------------------|-----------|----|
|------------------------|-----------|----|

| Symbol | Parameter | Conditions | Max. | Unit |
|------------------|--------------------|----------------|------|------|
| C _{IN} | Input Capacitance | $V_{IN} = 0V$ | 6 | pF |
| C _{OUT} | Output Capacitance | $V_{I/O} = 0V$ | 8 | pF |

NOTE:

1. This parameter is guaranteed and not tested.

Truth Table

| Mode | | CE2 | OE | WE | I/O Operation |
|----------------|---|-----|----|----|------------------|
| Standby | Н | Х | Х | Х | High Z |
| Standby | Х | L | Х | Х | High Z |
| Output Disable | L | н | Н | Н | High Z |
| Read | L | Н | L | Н | D _{OUT} |
| Write | L | Н | Х | L | D _{IN} |

NOTE:

X = Don't Care, L = LOW, H = HIGH

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| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Units |
|-----------------|------------------------------------|---|----------------------|------|----------------------|-------|
| V _{IL} | Input LOW Voltage ^(1,2) | | -0.5 | — | 0.4 | V |
| V _{IH} | Input HIGH Voltage ⁽¹⁾ | | 2.0 | _ | V _{CC} +0.3 | V |
| Ι _{ΙL} | Input Leakage Current | V_{CC} = Max, V_{IN} = 0V to V_{CC} | _ | | 1 | μA |
| I _{OL} | Output Leakage Current | $V_{CC} = Max, \overline{CE}_1 = V_{IH}, V_{OUT} = 0V \text{ to } V_{CC}$ | _ | | 1 | μA |
| V _{OL} | Output LOW Voltage | $V_{CC} = Min, I_{OL} = 2mA$ | _ | _ | 0.4 | V |
| V _{OH} | Output HIGH Voltage | V_{CC} = Min, I_{OH} = -0.5mA | V _{CC} -0.4 | | — | V |

DC Electrical Characteristics (over all temperature ranges, $V_{CC} = 2.3V-3.0V$)

| Symbol | ol Parameter | | | Ind. ⁽³⁾ | Units |
|------------------|--|-----------|-----|---------------------|-------|
| I _{CC1} | | | 35 | 40 | mA |
| | V _{CC} = Max. | f = 1 MHz | 4 | 5 | |
| I _{SB} | TTL Standby Current | L | 0.5 | 1 | mA |
| | $\overline{CE}_1 \ S \ V_{IH}, \ CE_2 \ \delta \ V_{IL}, \ V_{CC} = Max., \ f = 0$ | LL | 0.3 | 1 | |
| I _{SB1} | CMOS Standby Current, $\overline{CE}_1 \\ \\ S \\ V_{CC} - 0.2 \\ V, CE_2 \\ \\ \delta \\ 0.2 \\ V,$ | L | 10 | 15 | μA |
| | $V_{IN} \ \text{\r{S}} \ V_{CC} - 0.2 V \text{ or } V_{IN} \ \text{\r{o}} \ 0.2 V, \ V_{CC} = Max., \ f = 0$ | LL | 5 | 7 | |

NOTES:

1. These are absolute values with respect to device ground and all overshoots due to system or tester noise are included.

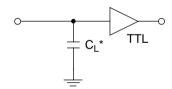
2. V_{IL} (Min.) = -3.0V for pulse width < $t_{RC}/2$.

3. Maximum value.

AC Test Conditions

| Input Pulse Levels | 0 to 2.0V |
|---------------------------|-----------|
| Input Rise and Fall Times | 5 ns |
| Timing Reference Levels | 1.1V |
| Output Load | see below |

AC Test Loads and Waveforms



 $C_L = 30pF + 1TTL Load$

* Includes scope and jig capacitance

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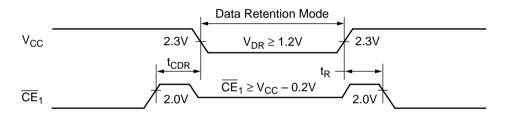
Data Retention Characteristics

| Symbol | Parameter | | Power | Min. | Тур. ⁽²⁾ | Max. | Units |
|-------------------|---|-------|-------|--------------------------------|---------------------|------|-------|
| V _{DR} | $\label{eq:V_CC} \begin{array}{l} V_{CC} \text{ for Data Retention} \\ \overline{CE}_1 \geq V_{CC} - 0.2 \text{V}, \ CE_2 < 0.2 \text{V}, \ V_{IN} \geq V_{CC} - 0.2 \text{V}, \\ \text{ or } V_{IN} \leq 0.2 \text{V} \end{array}$ | | | 1.2 | _ | 3.0 | V |
| I _{CCDR} | $\label{eq:lccdr} I_{CCDR} & \begin{array}{l} Data \ Retention \ Current \\ \hline CE_1 \geq V_{DR} - 0.2V, \ CE_2 < 0.2V, \ V_{IN} \geq V_{CC} - 0.2V, \\ or \ V_{IN} \leq 0.2V, \ V_{DR} = 1.2V \end{array}$ | Com'l | L | _ | 1 | 3 | μΑ |
| | | | LL | _ | 0.5 | 2 | |
| | | Ind. | L | _ | — | 5 | |
| | | | LL | _ | — | 4 | |
| t _{CDR} | Chip Deselect to Data Retention Time | • | | 0 | — | _ | ns |
| t _R | Operation Recovery Time (see Retention Waveform |) | | t _{RC} ⁽¹⁾ | _ | _ | ns |

NOTES:

- 1. t_{RC} = Read Cycle Time 2. T_A = +25°C.

Low V_{CC} Data Retention Waveform (1) (\overline{CE}_1 Controlled)



Key to Switching Waveforms

| WAVEFORM | INPUTS | OUTPUTS |
|------------------------|--|--|
| | MUST BE STEADY | WILL BE STEADY |
| | MAY CHANGE FROM H TO L | WILL BE CHANGING FROM H TO L |
| | MAY CHANGE FROM L TO H | WILL BE CHANGING FROM L TO H |
| | DON'T CARE: ANY CHANGE PERMITTED | CHANGING: STATE UNKNOWN |
| $\mathbb{P}\mathbb{C}$ | DOES NOT APPLY | CENTER LINE IS HIGH IMPEDANCE "OFF" STATE |

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AC Electrical Characteristics

(over all temperature ranges)

Read Cycle

| Parameter | | 70 | | 85 | | | |
|-------------------|------------------------------------|------|------|------|------|------|--|
| Name | Parameter | Min. | Max. | Min. | Max. | Unit | |
| ^t RC | Read Cycle Time | 70 | _ | 85 | _ | ns | |
| t _{AA} | Address Access Time | — | 70 | _ | 85 | ns | |
| t _{ACS1} | Chip Enable Access Time | — | 70 | _ | 85 | ns | |
| t _{ACS2} | Chip Enable Access Time | — | 70 | _ | 85 | ns | |
| ^t OE | Output Enable to Output Valid | — | 40 | _ | 85 | ns | |
| ^t CLZ1 | Chip Enable to Output in Low Z | 10 | _ | 10 | — | ns | |
| t _{CLZ2} | Chip Enable to Output in Low Z | 10 | _ | 10 | — | ns | |
| ^t OLZ | Output Enable to Output in Low Z | 5 | _ | 10 | — | ns | |
| ^t CHZ | Chip Disable to Output in High Z | — | 30 | _ | 30 | ns | |
| t _{OHZ} | Output Disable to Output in High Z | — | 25 | _ | 30 | ns | |
| t _{ОН} | Output Hold from Address Change | 10 | _ | 10 | — | ns | |

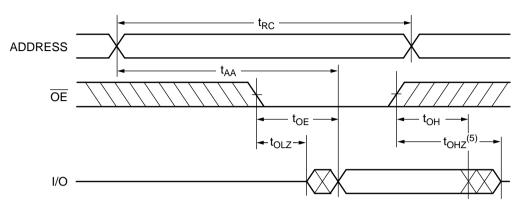
Write Cycle

| Parameter | | 70 | | 85 | | | |
|------------------|-------------------------------|------|------|------|------|------|--|
| Name | Parameter | Min. | Max. | Min. | Max. | Unit | |
| ^t WC | Write Cycle Time | 70 | _ | 85 | _ | ns | |
| ^t CW | Chip Enable to End of Write | 60 | _ | 70 | _ | ns | |
| t _{AS} | Address Setup Time | 0 | _ | 0 | _ | ns | |
| t _{AW} | Address Valid to End of Write | 60 | _ | 70 | _ | ns | |
| t _{WP} | Write Pulse Width | 50 | _ | 60 | _ | ns | |
| ^t WR | Write Recovery Time | 0 | _ | 0 | _ | ns | |
| ^t WHZ | Write to Output High-Z | — | 20 | _ | 25 | ns | |
| t _{DW} | Data Setup to End of Write | 35 | _ | 40 | _ | ns | |
| ^t DH | Data Hold from End of Write | 0 | _ | 0 | _ | ns | |

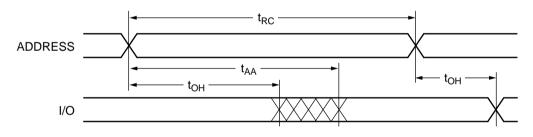
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Switching Waveforms (Read Cycle)

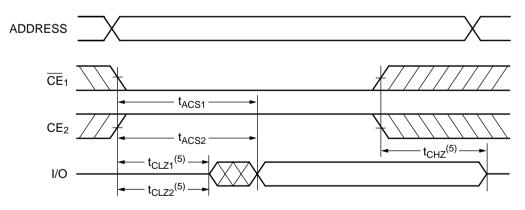
Read Cycle 1^(1, 2, 6)



Read Cycle 2^(1, 2, 4, 6)







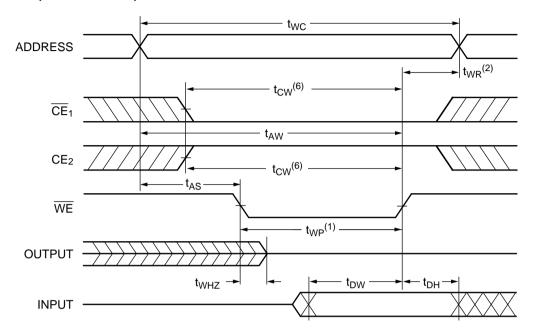
NOTES:

- 1.
- 2.
- $\frac{\overline{\mathsf{WE}}}{\overline{\mathsf{CE}}_1} = \mathsf{V}_{\mathsf{IL}} \text{ and } \mathsf{CE}_2 = \mathsf{V}_{\mathsf{IH}}.$ Address valid prior to or coincident with $\overline{\mathsf{CE}}_1$ transition LOW and/or CE_2 transition HIGH. 3.
- $\overline{OE} = V_{IL}$. 4.
- Transition is measured \pm 500mV from steady state with C_L = 5pF. This parameter is guaranteed and not 100% tested. 5.
- 6. CE₂ is offered on BGA package only.

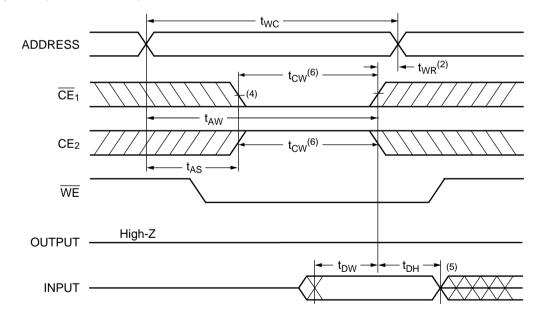
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Switching Waveforms (Write Cycle)

Write Cycle 1 (\overline{WE} Controlled)^(4, 7)



Write Cycle 2 (CE Controlled)^(4, 7)



NOTES:

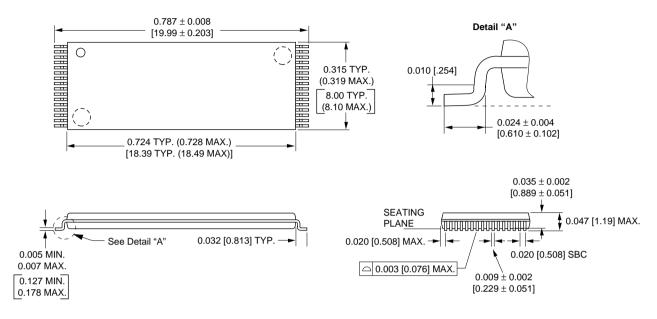
- The internal write time of the memory is defined by the overlap of CE₁ and CE₂ active and WE low. All signals must be active to initiate and any one signal can terminate a write by going inactive. The data input setup and hold timing should be referenced to the second transition edge of the signal that terminates the write.
- 2. t_{WR} is measured from the earlier of \overline{CE}_1 or \overline{WE} going high, or CE_2 going LOW at the end of the write cycle.
- 3. During this period, I/O pins are in the output state so that the input signals of opposite phase to the outputs must not be applied.
- 4. $\overline{OE} = V_{IL}$ or V_{IH} . However it is recommended to keep \overline{OE} at V_{IH} during write cycle to avoid bus contention.
- 5. If \overline{CE}_1 is LOW and CE_2 is HIGH during this period, I/O pins are in the output state. Then the data input signals of opposite phase to the outputs must not be applied to them.
- 6. t_{CW} is measured from \overline{CE}_1 going low or CE_2 going HIGH to the end of write.
- 7. CE₂ is offered on BGA package only.

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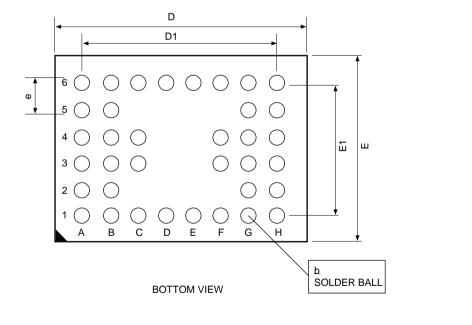
Package Diagrams

32-Pin TSOP (Standard)

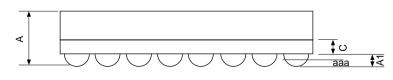
Units in inches [mm]



36 Ball-8x10 BGA



| SYMBOL | UNIT.MM |
|--------|------------|
| А | 1.05+0.15 |
| A1 | 0.25±0.05 |
| b | 0.35±.0.05 |
| с | 0.30(TYP) |
| D | 10.00±0.10 |
| D1 | 5.25 |
| Е | 8.00±0.10 |
| E1 | 3.75 |
| е | 0.75TYP |
| aaa | 0.10 |
| | |



SIDE VIEW

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